

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Seiichi Matsuoka	08/06/2005
Yoji Arakawa	08/06/2005
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Fuji Jukogyo Kabushiki Kaisha
<b>Street Address:</b>	7-2 Nishishinjuku 1-chome
<b>Internal Address:</b>	Shinjuku-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	160-0023
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	11212449
<b>CORRESPONDENCE DATA</b>	
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<b>Total Attachments: 2</b> source=image#page1.tif source=image#page2.tif	

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**PATENT**  
**REEL: 016597 FRAME: 0451**

**ASSIGNMENT**

WHEREAS, we,

(1) Seichi MATSUOKA of Shinjuku-ku, Tokyo, Japan

(2) Yoji ARAKAWA of Shinjuku-ku, Tokyo, Japan

have invented certain improvements in

Tank for Very Low Temperature Liquids

for which we have executed an application for Letters Patent of the United States of America, of even date herewith; and

WHEREAS, Fuji Jukogyo Kabushiki Kaisha (Assignee), a corporation organized and existing under the laws of Japan, having its principal office and place of business at 7-2 Nishishinjuku 1-chome, Shinjuku-ku, Tokyo, 160-0023, Japan, is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said Assignee, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said Assignee, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said

Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

First Inventor Name: Seichi MATSUOKA  
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Dated: August 6, 2005

Seichi Matsuo  
Inventor Signature

Dated: August 6, 2005

Yoshinari Ueta  
Witness Signature  
Witness Name: YOSHINARI UETA

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Second Inventor Name: Yoji ARAKAWA  
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Dated: August 6, 2005

Yoji Arakawa  
Inventor Signature

Dated: August 6, 2005

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